

FEATURES AND BENEFITS

- Sensitivity with B_{OP} as low as 10 G
- Ultra-low power consumption: ~2.4 μ A @ V_{DD} = 3.3 V and f_S = 500 Hz
- Supply voltage range: 1.7 V to 5.5 V
- Sensor polarity: bipolar
- Digital CMOS outputs:

 □ Push-pull
- Undervoltage lockout (UVLO)
- 3-lead SOT23 package

APPLICATIONS

- IoT devices
- Smartphones, tablets, and laptops
- · Door or lid closure
- Reed switch replacement
- Tamper-proofing for utility smart meters
- Fluid level sensing/detection
- · Proximity detection
- · Motor controllers
- · Gimbals for camera systems in drones/UAVs
- Industrial machinery/robots
- Medical devices

DESCRIPTION

The CT812x series of bipolar tunnel magnetoresistance (TMR) digital latches are designed for consumer and industrial applications. The devices are based on Allegro patented XtremeSenseTM TMR technology with integrated CMOS process to provide a monolithic solution for superior sensing performance. The CT812x digital latches offer stable magnetic operation over the operating temperature range.

This product family has very low power consumption—as low as $2.2~\mu A$ —which is ideal for battery-operated products where minimal current consumption is required. The devices support magnetic fields down to 10~G for applications where there is a large air gap requirement.

The CT812x is available in an industry-standard 3-lead SOT-23 package to support high-volume manufacturing for industrial markets.

PACKAGE:



3-lead SOT-23

Not to scale

FUNCTIONAL BLOCK DIAGRAM

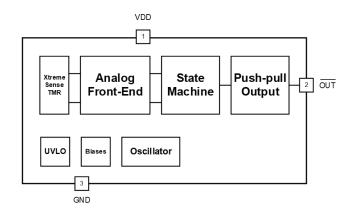


Figure 1: CT8122 with Push-Pull Output Block Diagram for 3-Lead SOT23 Package

Integrated Bipolar TMR Digital Latches

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SELECTION GUIDE

Part Number	Operating Temp. Range (°C)	Sensor Type	Output	B _{OP} (G)	B _{RP} (G)	f _S	Package	Packing
CT8122AN-IS3	-40 to 85	Bipolar	Push-Pull	+10	-10	500 Hz	3-lead SOT23	Tape and Reel
CT8122AN-HS3	-40 to 125	Bipolal Push-Pull	+10	-10	10 300 HZ	3-lead 50123	Tape and Reel	
CT8122AM-IS3	-40 to 85	Bipolar	Push-Pull	+10	-10	2.5 kHz	3-lead SOT23	Tape and Reel
CT8122AM-HS3	-40 to 125	Біроіаі	Push-Puli +10	+10 -10	-10	-10 2.5 KHZ	3-lead 50123	Tape and Reel



Integrated Bipolar TMR Digital Latches

ABSOLUTE MAXIMUM RATINGS [1]

Characteristic	Symbol	Notes	Rating	Unit
Supply Voltage	V _{DD}		-0.3 to 6.0	V
Push-Pull Output (Active Low)	V _{OUT_PP}		-0.3 to V _{DD} + 0.3 ^[2]	V
Open Drain Output (Active Low)	V _{OUT_OD}		-0.3 to 6.0	V
Analog Input/Output Pins Maximum Voltage	V _{I/O}		-0.3 to V _{DD} + 0.3 [2]	V
Input and Output Current	$I_{\text{IN}}, I_{\text{OUT}}$		±20.0	mA
Maximum External Magnetic Field	B _{MAX}	T _A = 25°C	±600	G
Electrostatic Discharge Protection Level	ESD	Human Body Model (HBM) per JESD22-A114	±4.0 (min)	kV
Electiostatic Discharge Protection Level	E9D	Charged Device Model (CDM) per JESD22-C101	±0.5 (min)	kV
Junction Temperature	TJ		-40 to 150	°C
Storage Temperature	T _{STG}		-65 to 150	°C
Lead Soldering Temperature	T _L	10 seconds	260	°C

^[1] Stresses exceeding the absolute maximum ratings may damage the CT812x and may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Allegro does not recommend exceeding or designing to absolute maximum ratings

RECOMMENDED OPERATING CONDITIONS [1]

Characteristic	Symbol	Notes	Min.	Тур.	Max.	Unit
Supply Voltage Range	V_{DD}		1.7	3.3	5.5	V
Output Voltage Range	V _{OUT}		0	_	V_{DD}	V
Operating Magnetic Flux	B _{OP}		_	_	300	G
Output Current	I _{OUT}		-	_	±3.0	mA
Bypass Capacitor	C _{BYP}		_	1.0	-	μF
Operating Ambient Temperature	T _A	Industrial	-40	25	85	°C
		Extended Industrial	-40	25	125	°C

^[1] The Recommended Operating Conditions table defines the conditions for actual operation of the CT812x. Recommended operating conditions are specified to ensure optimal performance to the specifications. Allegro does not recommend exceeding them or designing to absolute maximum ratings.

THERMAL CHARACTERISTICS

Characteristic	stic Symbol Test Conditions		Value	Unit
Junction-to-Ambient Thermal Resistance	R _{θJA}	Junction-to-ambient thermal resistance is a function of application and board layout and is determined in accordance to JEDEC standard JESD51 for a four (4) layer 2s2p FR-4 printed circuit board (PCB) with 2 oz. of copper (Cu) and 4 oz. of copper (Cu) or more for 65 A. Special attention must be paid not to exceed junction temperature T _{J(MAX)} at a given ambient temperature T _A .	202	°C/W



 $^{^{[2]}}$ The lower of V_{DD} + 0.3 V or 6.0 V.

PINOUT DIAGRAM AND TERMINAL LIST

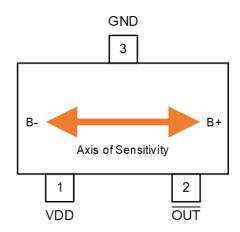


Figure 2: CT812x 3-Lead SOT23 Package for Digital Output (Top-Down View)

Terminal List

Number	Name	Function
1	VDD	Supply Voltage
2	OUT	Output Signal (Active Low)
3	GND	Ground



Integrated Bipolar TMR Digital Latches

ELECTRICAL CHARACTERISTICS: Valid for V_{DD} = 1.7 to 5.5 V, C_{BYP} = 1.0 μ F, and T_A = -40° C to 125 $^{\circ}$ C, typical values are V_{DD} = 3.3 V and T_A = 25 $^{\circ}$ C, unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
PUSH-PULL OUTPUT	'					
Output Voltage High OUT [1]	V _{OH}		0.9 × V _{DD}	_	- 1	V
Output Voltage Low OUT [1]	V _{OL}		_	_	0.1 × V _{DD}	V
OUT Current [1]	I _{OUT}		_	±2.0	_	mA
TIMINGS	·					
Power-On Time [1]	t _{ON}	V _{DD} ≥ 1.7 V	_	50	75	μs
Active Mode Time [1]	t _{ACTIVE}		_	2.6	_	μs
PROTECTION	'					
Lindonialta na Lagica († [1]	.,	Rising V _{DD}	_	1.60	1.64	V
Undervoltage Lockout [1]	V _{UVLO}	Falling V _{DD}	1.44	1.53	-	V
UVLO Hysteresis [1]	V _{UV_HYS}		_	70	-	mV

^[1] Guaranteed by design and characterization; not tested in production.

TYPICAL TIMING CHARACTERISTICS

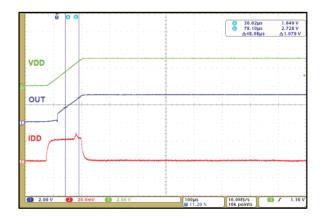


Figure 3: Power-On Time for Push-Pull Output

CT8122AN – ELECTRICAL CHARACTERISTICS and MAGNETIC SPECIFICATIONS: Uness otherwise specified, valid for V_{DD} = 1.7 to 5.5 V, C_{BYP} = 1.0 μ F, and T_A = -40°C to 125°C, typical values are V_{DD} = 3.3 V and T_A = 25°C

DD D11						
Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Avanage Complex Company	I _{DD(AVG)}	t ≥ 10 seconds	_	2.4	4.0	μA
Average Supply Current	I _{DD(AVG)_1.8V}	t ≥ 10 seconds, V _{DD} = 1.8 V	_	2.2	2.8	μA
Sampling Frequency	f _S		300	500	700	Hz
Idle Mode Time	t _{IDLE}	f _S = 500 Hz	1.4	2.0	3.3	ms
Operate Point, B+	B _{OPS}		7	10	13	G
Release Point, B-	B _{RPN}		-13	-10	-7	G

CT8122AM – ELECTRICAL CHARACTERISTICS and MAGNETIC SPECIFICATIONS: Uness otherwise specified, valid for V_{DD} = 1.7 to 5.5 V, C_{BYP} = 1.0 μ F, and T_{A} = -40°C to 125°C, typical values are V_{DD} = 3.3 V and T_{A} = 25°C

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Average Supply Current	I _{DD(AVG)}	t ≥ 10 seconds	-	11.5	15.0	μΑ
Average Supply Current	I _{DD(AVG)_1.8V}	t ≥ 10 seconds, V _{DD} = 1.8 V	_	10.5	12.0	μΑ
Sampling Frequency	f _S		1.5	2.5	3.5	kHz
Idle Mode Time	t _{IDLE}	f _S = 2.5 kHz	285	400	667	μs
Operate Point, B+	B _{OPS}		7	10	13	G
Release Point, B-	B _{RPN}		-13	-10	– 7	G

TYPICAL MAGNETIC CHARACTERISTICS FOR CT8122Ax

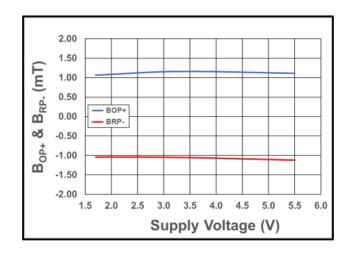


Figure 4: B_{OP} (Blue) and B_{RP} (Red) vs. Supply Voltage at $T_A = 25$ °C

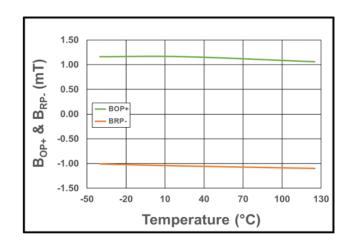
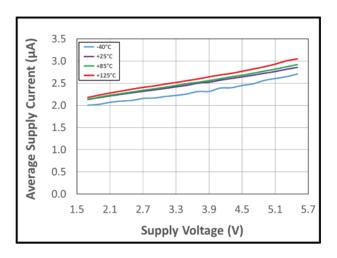


Figure 5: B_{OP} (Green) and B_{RP} (Orange) vs. Temperature at V_{DD} = 3.3 V



TYPICAL ELECTRICAL CHARACTERISTICS FOR CT8122AN



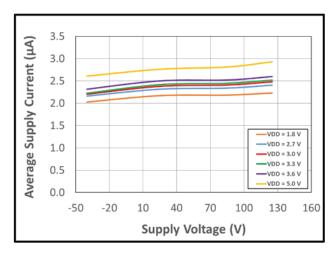


Figure 6: Average Supply Current vs. Supply Voltage vs. Temperature

Figure 7: Average Supply Current vs. Temperature vs. Supply Voltage

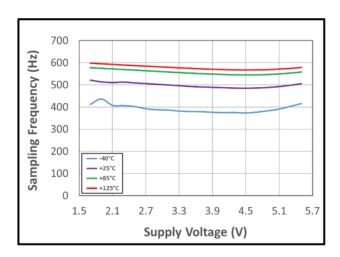
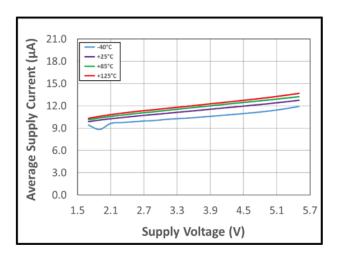


Figure 8: Sampling Frequency vs. Supply Voltage vs. Temperature



TYPICAL ELECTRICAL CHARACTERISTICS FOR CT8122AM



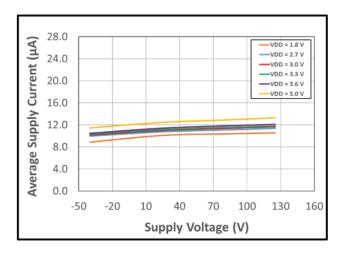


Figure 9: Average Supply Current vs. Supply Voltage vs. Temperature

Figure 10: Average Supply Current vs. Temperature vs. Supply Voltage

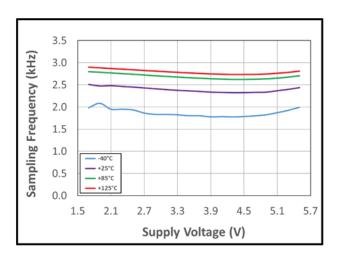


Figure 11: Sampling Frequency vs. Supply Voltage vs. Temperature



FUNCTIONAL DESCRIPTION

Overview

The CT812x is a product family of bipolar TMR magnetic latches that supports a wide operating voltage range of 1.7 to 5.5 V and is capable of providing a digital push-pull output. These bipolar TMR digital latches are designed to consume a minimal amount of current which is ideal for battery-operated products. It also supports a wide range of sensitivity levels for various applications.

Undervoltage Lockout (UVLO)

The Undervoltage Lockout protection circuitry of the CT812x is activated when the supply voltage (V_{DD}) falls below 1.53 V. The CT812x remains in a low quiescent state and the \overline{OUT} output is not valid until V_{DD} rises above the UVLO threshold (1.60 V).

Power-On Time (ton)

The Power-On Time (t_{ON}) of 50 μs is the amount of time required by the CT812x to start up, power-on, and acquire the first sample. The chip is fully powered up and operational from the moment the supply voltage passes the rising UVLO point (1.60 V). This time includes the ramp-up time and the settling time (within 10% of steady-state voltage under an applied magnetic field) after the power supply have reach the minimum V_{DD} .

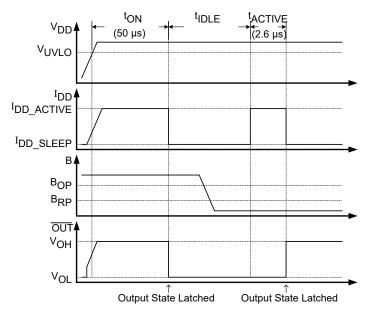


Figure 12: CT812x Power-On Timing Diagram

Bipolar Magnetic Flux

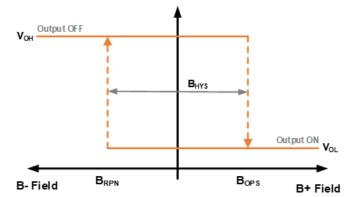


Figure 13: CT812x Output Behavior vs. Magnetic Field

Table 1: CT8121 Output Behavior

Magnetic Field	Condition	Output
Positive Field	B > B _{OPS}	Low (ON)
Negative Field	B < B _{OPN}	High (OFF)



APPLICATIONS INFORMATION

The CT812x products require a 1.0 µF (ceramic) bypass capacitor to be connected between the supply voltage and ground.

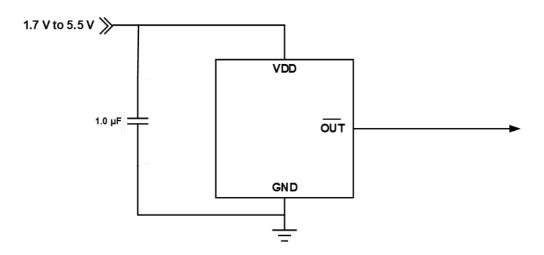


Figure 14: CT8121 Application Block Diagram



XtremeSense TMR Current Sensor Location

The XtremeSense TMR sensor location for the CT812x products are shown in Figure 15. The dimensions shown are typical values.

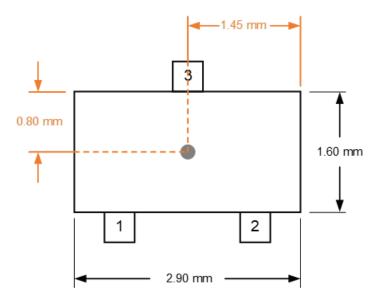


Figure 15: XtremeSense TMR Sensor Location for CT812x products in 3-lead SOT23 Package



PACKAGE OUTLINE DRAWING

For Reference Only - Not for Tooling Use

Dimensions in millimeters – NOT TO SCALE sexclusive of mold flash, gate burs, and dambar profi

Dimensions exclusive of mold flash, gate burs, and dambar protrusions Exact case and lead configuration at supplier discretion within limits shown

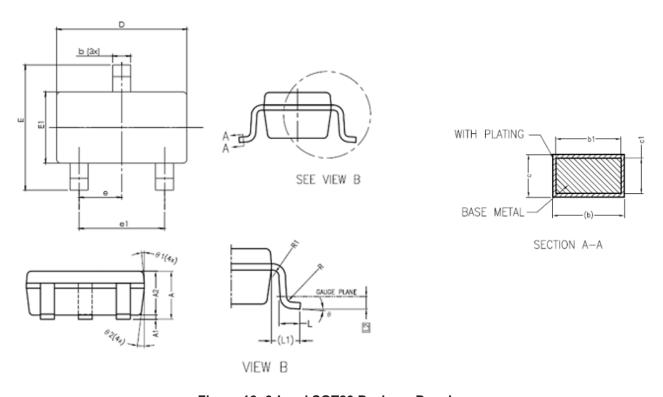


Figure 16: 3-Lead SOT23 Package Drawing

Table 2: CT812x 3-Lead SOT23 Package Dimensions

Sumbal	Dimensions in Millimeters (mm)				
Symbol	Min.	Тур.	Max.		
Α	1.05	1.20	1.35		
A1	0.00	0.10	0.15		
A2	1.00	1.10	1.20		
b	0.30	_	0.50		
b1	0.30	0.35	0.45		
С	0.08	_	0.22		
c1	0.08	0.13	0.20		
D	2.80	2.90	3.00		
Е	2.60	2.80	3.00		
E1	1.50	1.60	1.70		

Cumbal	Dimensions in Millimeters (mm)				
Symbol	Min.	Min. Typ.			
е		0.95 BSC			
e1		1.90 BSC			
L	0.35	0.43	0.60		
L1		0.50 REF			
L2		0.25 BSC			
R	0.10	_	_		
R1	0.10	_	0.25		
θ	0° 4° 8°				
θ1	5°	5° 6° 15°			
θ2	5°	5° 8° 15°			



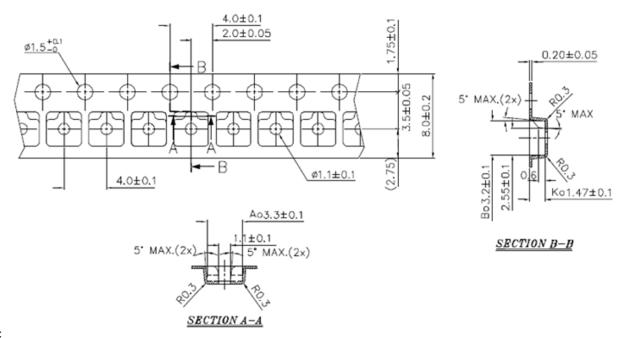
TAPE AND REEL POCKET DRAWING AND DIMENSIONS

For Reference Only – Not for Tooling Use

Dimensions in millimeters – NOT TO SCALE

Dimensions exclusive of mold flash, gate burs, and dambar protrusions

Exact case and lead configuration at supplier discretion within limits shown



NOTES:

- 1. Material: Conductive Polystyrene.
- 2. Dimensions in mm.
- 3. 10 sprocket hole pitch cumulative tolerance ± 0.20 mm.
- 4. Camber not to exceed 1 mm in 100 mm.
- 5. Pocket position relative to sprocket hole measured as true position of pocket and not pocket hole.
- 6. (S.R. Ω /sq) means surface electric resistivity of the carrier tape.

Figure 17: Tape and Pocket Drawing for 3-lead SOT23 Package

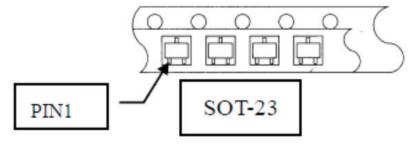


Figure 18: SOT23 Orientation in Tape Pocket



Integrated Bipolar TMR Digital Latches

PACKAGE INFORMATION

Table 3: CT812x Package Information

Part Number	Package Type	# of Leads	Package Quantity	Lead Finish	Eco Plan [1]	MSL Rating [2]	Operating Temperature (°C) [3]	Device Marking ^[4]
CT8122AN-IS3	SOT23	3	3000	Sn	Green & RoHS	1	-40 to 85	MS YWWS
CT8122AN-HS3	SOT23	3	3000	Sn	Green & RoHS	1	-40 to 125	MS YWWS
CT8122AM-IS3	SOT23	3	3000	Sn	Green & RoHS	1	-40 to 85	MR YWWS
CT8122AM-HS3	SOT23	3	3000	Sn	Green & RoHS	1	-40 to 125	MR YWWS

^[1] RoHS is defined as semiconductor products that are compliant to the current EU RoHS requirements. It also will meet the requirement that RoHS substances do not exceed 0.1% by weight in homogeneous materials. Green is defined as the content of chlorine (CI), bromine (Br), and antimony trioxide based flame retardants satisfy JS709B low halogen requirements of ≤ 1,000 ppm.



^[2] MSL Rating = Moisture Sensitivity Level Rating as defined by JEDEC standard classifications.

^[3] Package will withstand ambient temperature range of -40°C to 150°C and storage temperature range of -65°C to 150°C.

^[4] Device Marking for SOT23 is defined as XZ YWWS where XZ = part number, Y = year, WW = work week, and S = sequential number.

Integrated Bipolar TMR Digital Latches

Revision History

Number	Date	Description			
2	December 11, 2023	Document rebranded and minor editorial updates			
3	June 5, 2024	Added notes to package drawings (pages 12 and 13)			
4	March 27, 2025	Updated power-on timing diagram (page 9)			

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